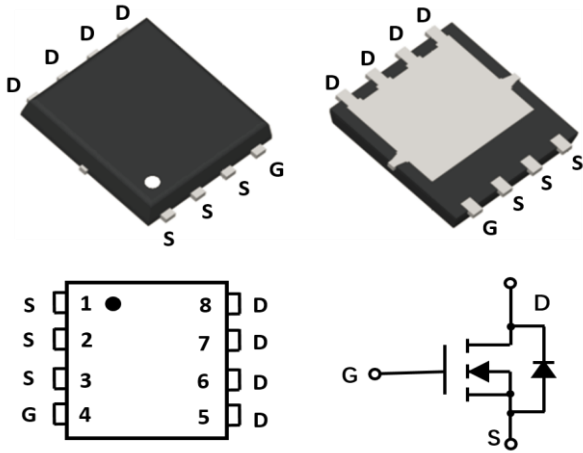


## N-Channel Enhancement Mode Field Effect Transistor

### PDFN5060-8L



### Product Summary

- $V_{DS}$  40 V
- $I_D$  130 A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) < 1.8 mohm
- $R_{DS(ON)}$  (at  $V_{GS}=4.5V$ ) < 3.0 mohm
- 100% UIS Tested
- 100%  $\nabla V_{DS}$  Tested

### General Description

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

### Applications

- Consumer electronic power supply
- Motor control
- Synchronous- rectification
- Invertors

### ■ Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	$V_{DS}$	40	V
Gate-source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current <sup>A</sup>	$I_D$	$T_C=25^\circ C$	130
		$T_C=100^\circ C$	82
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	390	A
Avalanche energy <sup>C</sup>	$E_{AS}$	200	mJ
Total Power Dissipation <sup>D</sup>	$P_D$	$T_C=25^\circ C$	140
		$T_C=100^\circ C$	56
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.89	$^\circ C/W$
Thermal resistance, junction-ambient <sup>E</sup>	$R_{\theta JA}$	62	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+150	$^\circ C$

### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJG130G04A	F1	YJG130G04A	5000	10000	100000	13" reel



# YJG130G04A

## ■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	40			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.8	2.5	V
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> =55A		1.3	1.8	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> =55A		2.0	3.0	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V			1.3	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>				130	A
<b>Dynamic Parameters</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1MHZ		6587		pF
Output Capacitance	C <sub>oss</sub>			2537		
Reverse Transfer Capacitance	C <sub>rss</sub>			179		
<b>Switching Parameters</b>						
Total Gate Charge	Q <sub>g (10V)</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =20A		96.8		nC
Total Gate Charge	Q <sub>g (4.5V)</sub>			41.1		
Gate-Source Charge	Q <sub>gs</sub>			14.5		
Gate-Drain Charge	Q <sub>gd</sub>			18.4		
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =20A, di/dt=100A/us		557		
Reverse Recovery Time	t <sub>rr</sub>			205		
Turn-on Delay Time	t <sub>D(on)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =20V, R <sub>L</sub> =2Ω I <sub>D</sub> =20A		26.6		ns
Turn-on Rise Time	t <sub>r</sub>			9.3		
Turn-off Delay Time	t <sub>D(off)</sub>			96		
Turn-off fall Time	t <sub>f</sub>			39		

- A. Calculated continuous current based on maximum allowable junction temperature.  
 B. Repetitive rating; pulse width limited by max. junction temperature.  
 C. V<sub>DD</sub>=30 V, R<sub>G</sub>=50 Ω, L=0.3 mH, starting T<sub>J</sub>=25 °C.  
 D. Pd is based on max. junction temperature, using junction-case thermal resistance.  
 E. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25 °C.



## ■ Typical Performance Characteristics

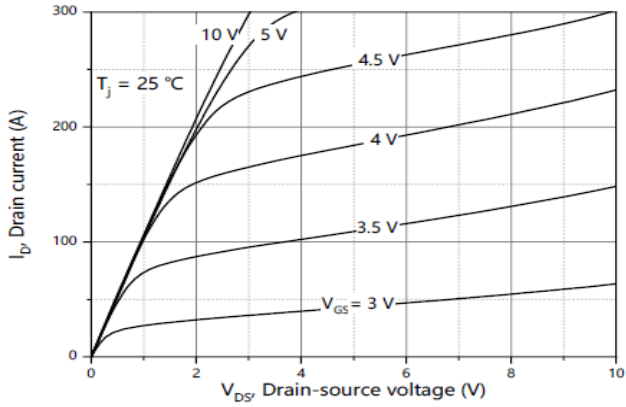


Figure1. Output Characteristics

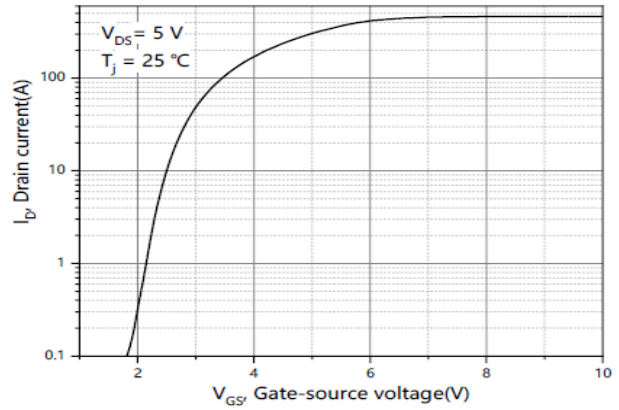


Figure2. Transfer Characteristics

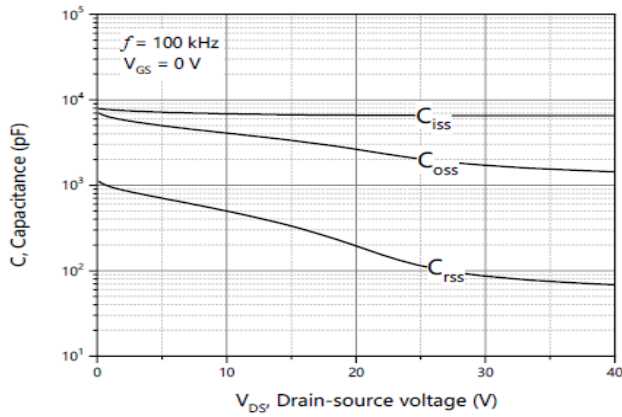


Figure3. Capacitance Characteristics

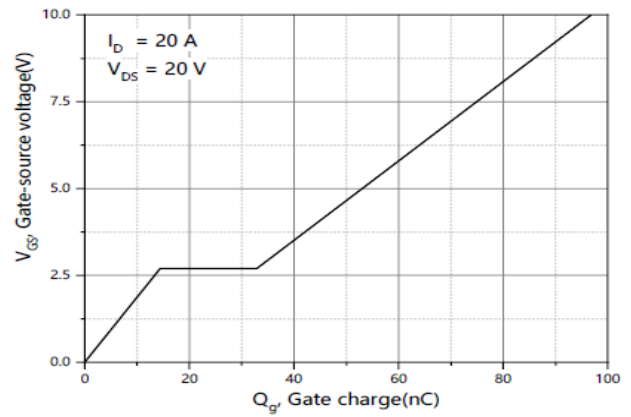


Figure4. Gate Charge

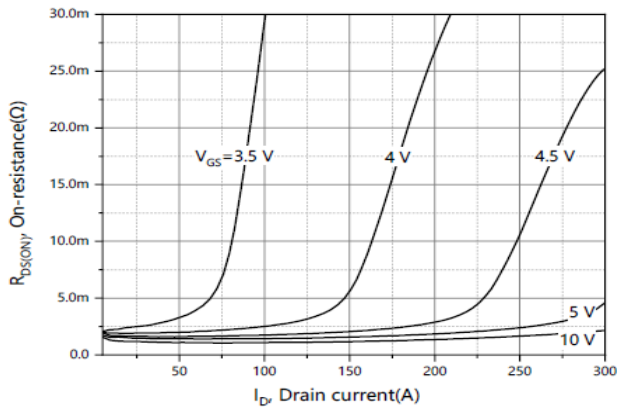


Figure5. Drain-Source on Resistance

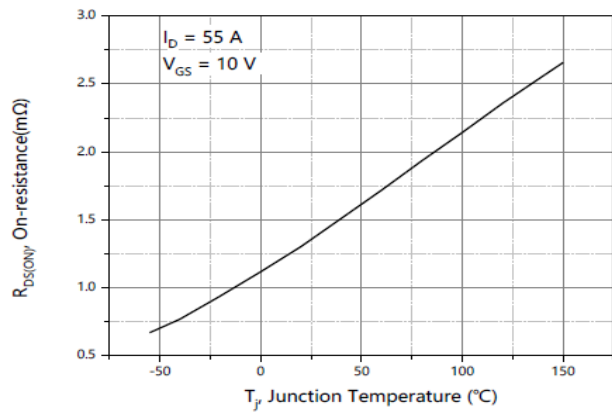


Figure6. Drain-Source on Resistance



# YJG130G04A

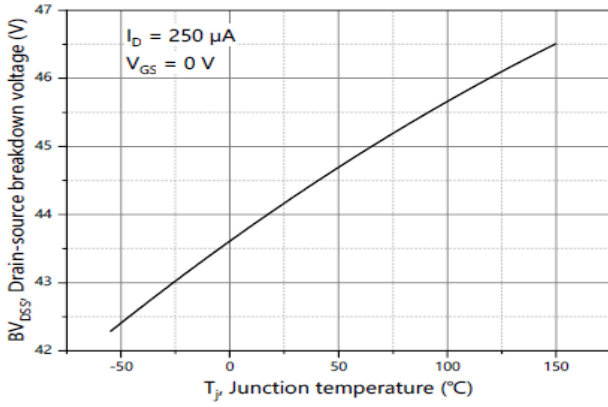


Figure7. Drain-Source Breakdown Voltage

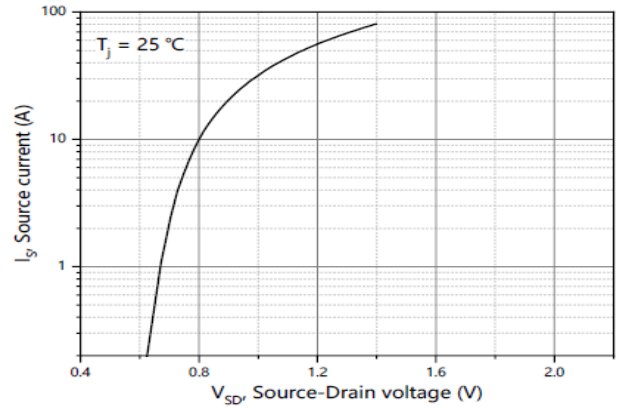


Figure8. Forward Characteristic of Body Diode

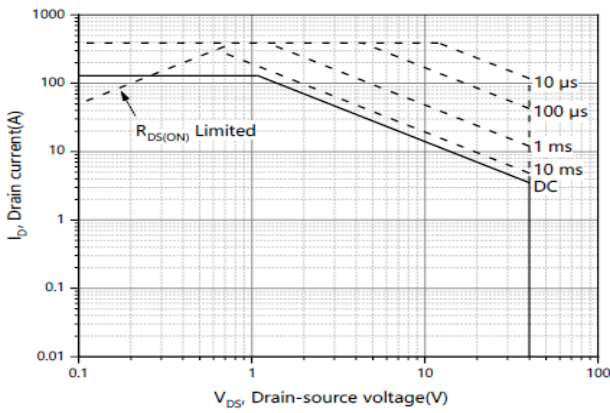


Figure9. Safe Operation Area

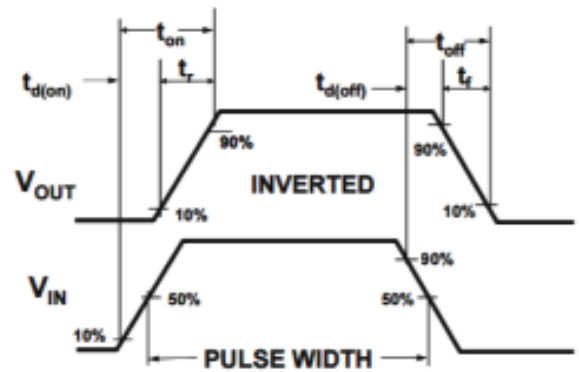
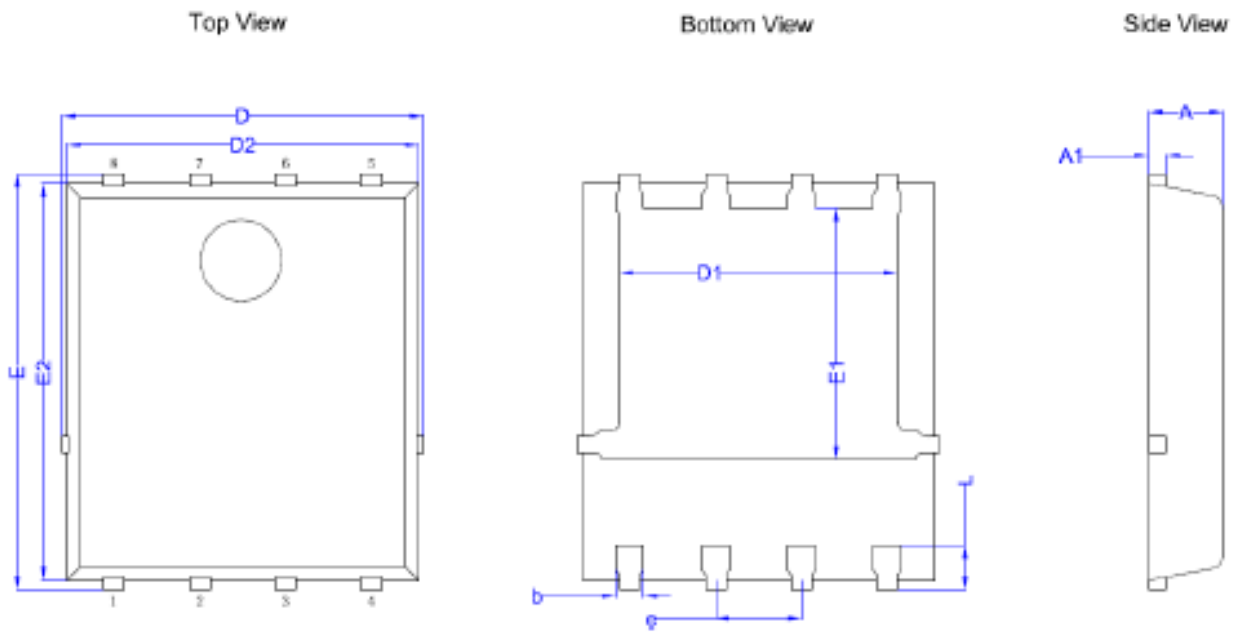


Figure10. Switching wave



# YJG130G04A

## ■ PDFN5060-8L Package information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	1.00	1.10	1.20
A1	0.254 BSC		
D	5.15	5.35	5.55
E	5.95	6.15	6.35
D1	3.92	4.12	4.32
E1	3.52	3.72	3.92
D2	5.00	5.20	5.40
E2	5.66	5.86	6.06
e	1.27BSC		
b	0.31	0.41	0.51
L	0.56	0.66	0.76



# YJG130G04A

---

## Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website [http:// www.21yangjie.com](http://www.21yangjie.com) , or consult your nearest Yangjie's sales office for further assistance.